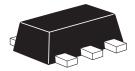
MPPS™ 30V PNP LOW SATURATION MEDIUM POWER TRANSISTOR IN SOT89

SUMMARY

 BV_{CEO} = -30V : R_{SAT} = 24m Ω ; I_{C} = -5.5A

DESCRIPTION

Packaged in the SOT89 outline this new 5th generation low saturation 30V PNP transistor offers low on state losses making it ideal for use in DC-DC circuits, line switching and various driving and power management functions.



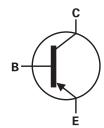
SOT89

FEATURES

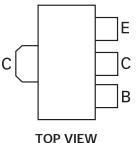
- 5.5 Amps continuous current
- Up to 20 Amps peak current
- Very low saturation voltages
- Exceptional gain linearity down to 10mA
- Excellent high current gain hold up

APPLICATIONS

- DC DC converters
- MOSFET gate drivers
- · Charging circuits
- Power switches
- Motor control



PINOUT



ORDERING INFORMATION

DEVICE	REEL SIZE	TAPE WIDTH	QUANTITY PER REEL
ZX5T949ZTA	7"	12mm embossed	1000 units

DEVICE MARKING

• 949



ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	LIMIT	UNIT
Collector-base voltage	BV _{CBO}	-50	V
Collector-emitter voltage	$\mathrm{BV}_{\mathrm{CEO}}$	-30	V
Emitter-base voltage	BV _{EBO}	-7	V
Continuous collector current ^(a)	I _C	-5.5	А
Peak pulse current	Ісм	-20	А
Power dissipation at T _A =25°C ^(a)	P_{D}	1.5	W
Linear derating factor		12	mW/°C
Power dissipation at T _A =25°C ^(b)	P _D	2.1	W
Linear derating factor		16.8	mW/°C

THERMAL RESISTANCE

PARAMETER	SYMBOL	VALUE	UNIT
Junction to Ambient ^(a)	$R_{\Theta JA}$	83	°C/W
Junction to Ambient ^(b)	$R_{\Theta JA}$	60	°C/W

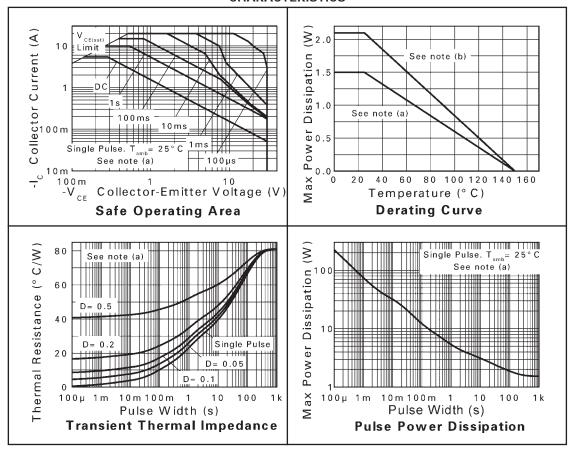
NOTES

(a) For a device surface mounted on 25mm x 25mm x 1.6mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions.



⁽b) For a device surface mounted on 50mm x 50mm x 1.6mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions.

CHARACTERISTICS



ZETEX

ELECTRICAL CHARACTERISTICS (at T_{amb} = 25°C unless otherwise stated)

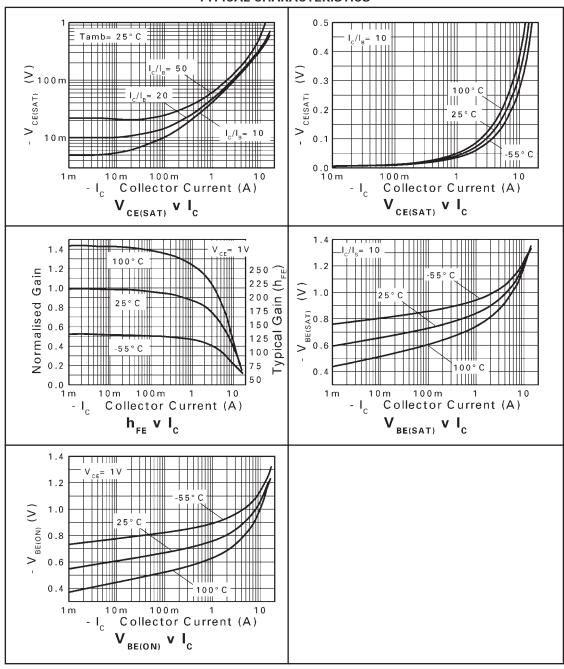
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	CONDITIONS
Collector-base breakdown voltage	BV _{CBO}	-50	-70		V	I _C = -100μA
Collector-emitter breakdown voltage	BV _{CER}	-50	-70		V	$I_C = -1\mu A$, RB < $1k\Omega$
Collector-emitter breakdown voltage	BV _{CEO}	-30	-40		V	I _C = -10mA *
Emitter-base breakdown voltage	BV _{EBO}	-7.0	-8.0		V	I _E = -100μA
Collector cut-off current	I _{CBO}		<-1	-20	nA	V _{CB} = -40V
				-0.5	μΑ	$V_{CB} = -40V, T_{amb} = 100^{\circ}C$
Collector cut-off current	I _{CER}		<-1	-20	nA	V _{CB} = -40V
	R <1kΩ			-0.5	μΑ	$V_{CB} = -40V, T_{amb} = 100^{\circ}C$
Emitter cut-off current	I _{EBO}		<-1	-10	nA	V _{EB} = -6V
Collector-emitter saturation voltage	V _{CE(SAT)}		-25	-40	mV	I _C = -0.5A, I _B = -20mA *
			-35	-55	mV	I _C = -1A, I _B = -100mA *
			-55	-80	mV	I _C = -1A, I _B = -20mA *
			-55	-80	mV	$I_C = -2A$, $I_B = -200mA$ *
			-130	-175	mV	I _C = -5.5A, I _B =-500mA *
Base-emitter saturation voltage	V _{BE(SAT)}		-970	-1070	mV	I _C = -5.5A, I _B = -500mA *
Base-emitter turn-on voltage	V _{BE(ON)}		-860	-960	mV	I _C = -5.5A, V _{CE} = -1V *
Static forward current transfer ratio	h _{FE}	100	225			I _C = -10mA, V _{CE} = -1V *
		100	200	300		I _C = -1A, V _{CE} = -1V *
		70	145			I _C = -5A, V _{CE} = -1V *
		10	20			I _C = -20A, V _{CE} = -1V *
Transition frequency	f _T		110		MHz	I _C = -100mA, V _{CE} = -10V
						f = 50MHz
Output capacitance	C _{OBO}		83		pF	V _{CB} = -10V, f = 1MHz *
Switching times	t _{ON}		43		ns	I _C = -1A, V _{CC} = -10V,
	t _{OFF}		230			$I_{B1} = -I_{B2} = -100 \text{mA}$

NOTES



^{*} Measured under pulsed conditions. Pulse width $\leq 300 \mu s;$ duty cycle $\leq 2 \%.$

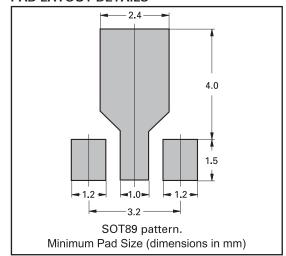
TYPICAL CHARACTERISTICS





PACKAGE OUTLINE

PAD LAYOUT DETAILS



Controlling dimensions are in millimeters. Approximate conversions are given in inches

PACKAGE DIMENSIONS

DIM	Millin	neters	Inc	hes	DIM		neters	Inches	
DIIVI	Min	Max	Min	Max	DIIVI	Min	Max	Min	Max
Α	1.40	1.60	0.550	0.630	е	1.40	1.50	0.055	0.059
b	0.38	0.48	0.015	0.019	E	3.75	4.25	0.150	0.167
b1	-	0.53	-	0.021	E1	-	2.60	-	0.102
b2	1.50	1.80	0.060	0.071	G	2.90	3.00	0.114	0.118
С	0.28	0.44	0.011	0.017	Н	2.60	2.85	0.102	0.112
D	4.40	4.60	0.173	0.181	-	-	-	-	-

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Europe	Americas	Asia Pacific	Corporate Headquaters
Zetex GmbH	Zetex Inc	Zetex (Asia) Ltd	Zetex Semiconductors plc
Streitfeldstraße 19	700 Veterans Memorial Hwy	3701-04 Metroplaza Tower 1	Lansdowne Road, Chadderton
D-81673 München	Hauppauge, NY 11788	Hing Fong Road, Kwai Fong	Oldham, OL9 8NP
Germany	USA	Hong Kong	United Kingdom
Telefon: (49) 89 45 49 49 0	Telephone: (1) 631 360 2222	Telephone: (852) 26100 611	Telephone (44) 161 622 4444
Fax: (49) 89 45 49 49 49	Fax: (1) 631 360 8222	Fax: (852) 24250 494	Fax: (44) 161 622 4446
europe.sales@zetex.com	usa.sales@zetex.com	asia.sales@zetex.com	hq@zetex.com

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